

1A, 200V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low reverse leakage
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- General purpose

MECHANICAL DATA

- Case: SMAF
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.035g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	1	A
V_{RRM}	200 - 1000	V
I_{FSM}	30	A
$T_{J\ MAX}$	150	°C
Package	SMAF	
Configuration	Single die	


**HALOGEN
FREE**

SMAF


ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	SYMBOL	RS1DF-T	RS1GF-T	RS1JF-T	RS1KF-T	RS1MF-T	UNIT
Marking code on the device		RS1DF	RS1GF	RS1JF	RS1KF	RS1MF	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V
Forward current	I_F	1					A
Surge peak forward current single half sine-wave superimposed on rated load	$t = 8.3\text{ms}$	I_{FSM} 30					A
	$t = 1.0\text{ms}$	90					A
Junction temperature	T_J	-55 to +150					°C
Storage temperature	T_{STG}	-55 to +150					°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	15	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	89	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	22	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	RS1DF-T RS1GF-T	I _F = 0.5A, T _J = 25°C	V _F	0.93	-	V
		I _F = 1.0A, T _J = 25°C		1.00	1.30	V
		I _F = 0.5A, T _J = 125°C		0.76	-	V
		I _F = 1.0A, T _J = 125°C		0.85	1.00	V
	RS1JF-T	I _F = 0.5A, T _J = 25°C		0.92	-	V
		I _F = 1.0A, T _J = 25°C		1.00	1.30	V
		I _F = 0.5A, T _J = 125°C		0.75	-	V
		I _F = 1.0A, T _J = 125°C		0.84	1.07	V
	RS1KF-T RS1MF-T	I _F = 0.5A, T _J = 25°C		0.98	-	V
		I _F = 1.0A, T _J = 25°C		1.06	1.30	V
		I _F = 0.5A, T _J = 125°C		0.83	-	V
		I _F = 1.0A, T _J = 125°C		0.92	1.23	V
Reverse current @ rated V _R ⁽²⁾		T _J = 25°C	I _R	-	5	μA
		T _J = 125°C		-	200	μA
Reverse recovery time	RS1DF-T RS1GF-T	I _F = 0.5A, I _R = 1.0A I _{rr} = 0.25A	t _{rr}	-	150	ns
	RS1JF-T			-	250	ns
	RS1KF-T RS1MF-T			-	500	ns
Junction capacitance	RS1DF-T RS1GF-T RS1JF-T	1MHz, V _R = 4.0V	C _J	9	-	pF
	RS1KF-T RS1MF-T			8	-	pF

Notes:

1. Pulse test with $PW = 0.3\text{ms}$
2. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
RS1xF-T	SMAF	7,500 / Tape & Reel

Notes:

1. "x" defines voltage from 200V (RS1DF-T) to 1000V (RS1MF-T)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

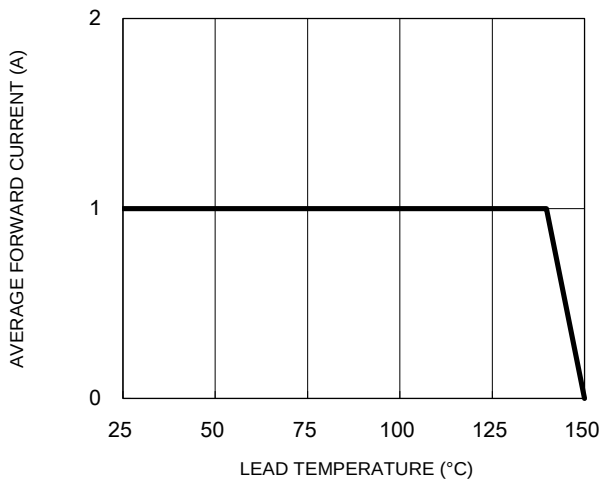


Fig.2 Typical Junction Capacitance

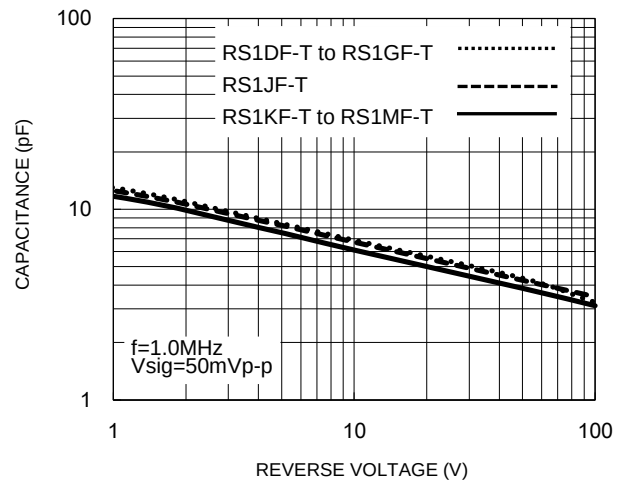


Fig.3 Typical Reverse Characteristics

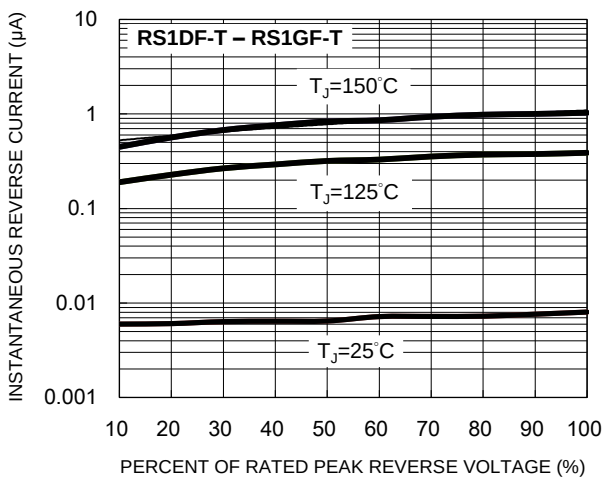


Fig.4 Typical Forward Characteristics

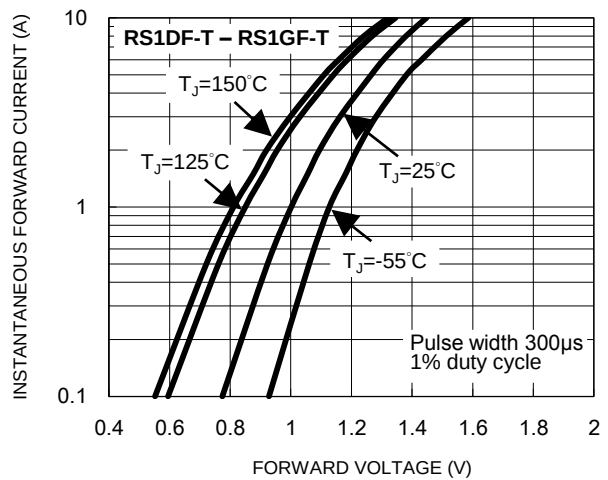


Fig.5 Typical Reverse Characteristics

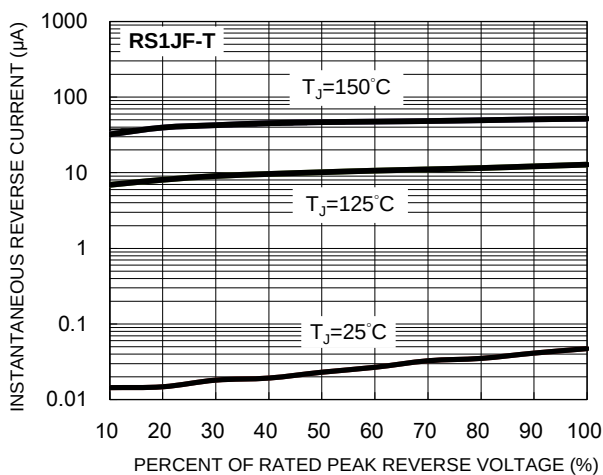
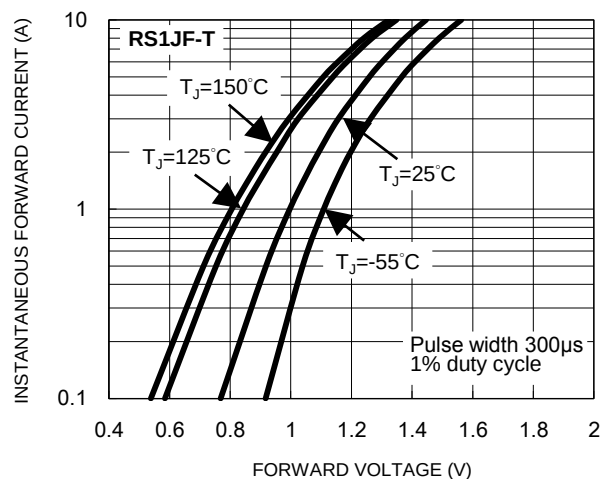


Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.7 Typical Reverse Characteristics

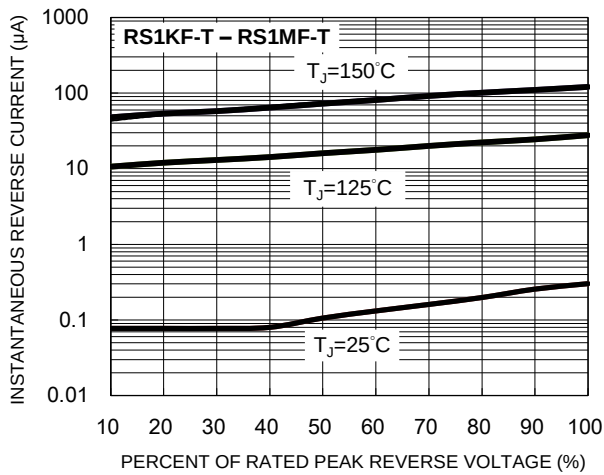


Fig.8 Typical Forward Characteristics

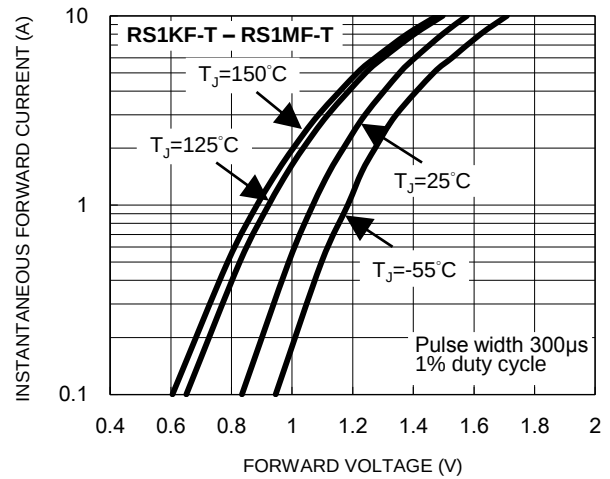
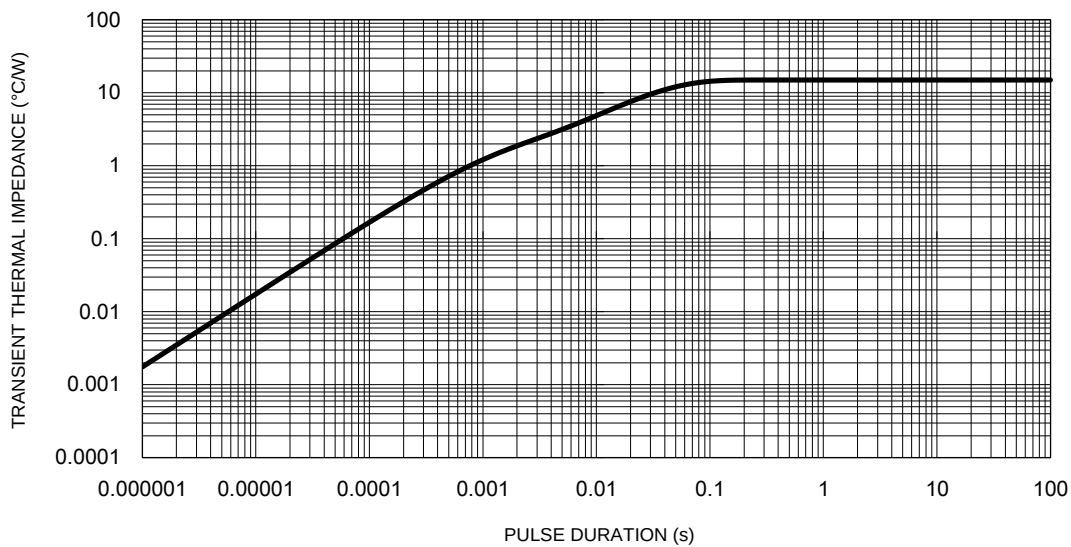
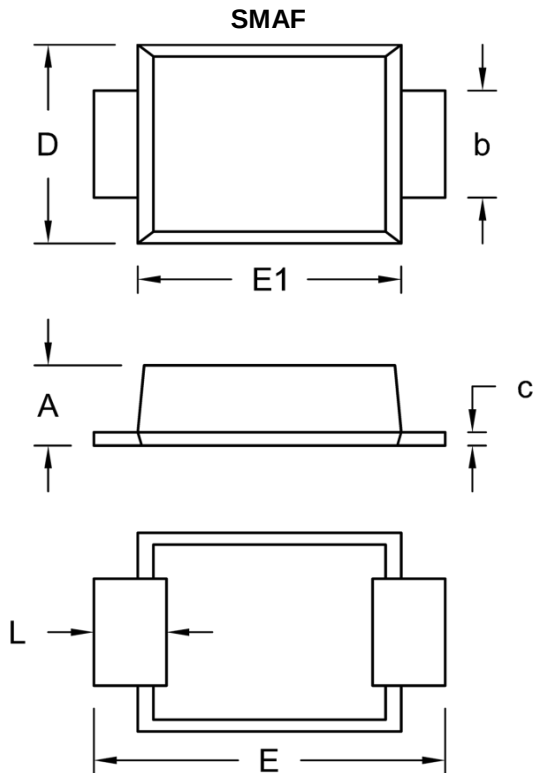


Fig.9 Typical Transient Thermal Impedance

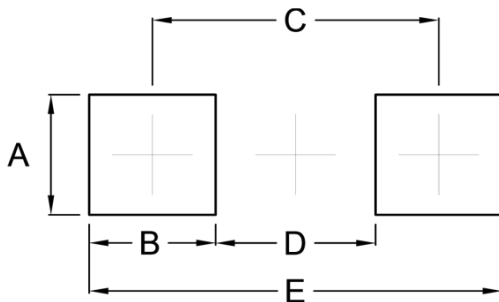


PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	1.00	1.10	0.039	0.043
b	1.30	1.50	0.051	0.059
c	0.10	0.25	0.004	0.010
D	2.40	2.80	0.094	0.110
E	4.40	4.80	0.173	0.189
E1	3.25	3.65	0.128	0.144
L	0.70	1.20	0.028	0.047

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.57	0.062
B	1.66	0.065
C	3.76	0.148
D	2.10	0.083
E	5.42	0.213

MARKING DIAGRAM



P/N = Marking Code
 G = Green Compound
 YW = Date Code
 F = Factory Code

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